

Efficient Planar Perovskite Solar Cells Using Passivated Tin Oxide as an Electron Transport Layer

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Planar perovskite solar cells using low-temperature atomic layer deposition (ALD) of the SnO₂ electron transporting layer (ETL), with excellent electron extraction and hole-blocking ability, offer significant advantages compared with high-temperature deposition methods. The optical, chemical, and electrical properties of the ALD SnO₂ layer and its influence on the device performance are investigated. It is found that surface passivation of SnO₂ is essential to reduce charge recombination at the perovskite and ETL interface and show that the fabricated planar perovskite solar cells exhibit high reproducibility, stability, and power conversion efficiency of 20%.

Over the past few years, there have been tremendous research and development in perovskite solar cells.^[1] Such a blistering interest is due to ease in the fabrication of perovskite solar cells using low-cost solution processes methods, which enabled high power conversion efficiencies (PCE) over 22%.^[2–5] For perovskite solar cells in an n-i-p configuration, TiO₂ has been widely used as an electron transporting layer (ETL) because of its favorable bandgap edge positions in relation to perovskite conduction band, and reduced processing costs.^[6] However, high-temperature deposition and poor charge collection at the TiO₂/perovskite interface are hindering for wider application of TiO₂ in planar perovskite solar cells.^[7–9] In this respect, SnO₂ that has a higher electron mobility is an excellent candidate to replace TiO₂.^[10] A wide bandgap ranging from 3.6 to 4.1 eV and chemical stability show a great potential of SnO₂ as an efficient electrode.^[11] Nevertheless, metal-like nature shown

in degenerated semiconductors seems to generate a serious shunting pathway decreasing the fill factor (FF) and an open-circuit voltage (V_{oc}).^[12,13] The recent data on surface treatments in perovskite solar cells signify the importance of surface passivation for the SnO₂ layer.^[13,14] Within this understanding, it is not surprising to find that the SnO₂ layer often positions as a sublayer that can function as a surface leveler and assisting ones for the primary ETL such as TiO₂ or phenyl-C₆₀-butyric acid methyl ester (PCBM) in normal and inverted type perovskite solar cells.^[15] We

have demonstrated that a severe drop of the V_{oc} and the PCE in the devices using solution-processed SnO₂ films heat-treated at high temperature.^[13] The low PCE is due to the deteriorated hole-blocking ability of the SnO₂ ETL caused by loss of the self-passivating SnOCl₂. In this article, we prove that the low-temperature process for the SnO₂ ETL is an indispensable choice to reduce charge recombination for photovoltaic applications.

The atomic layer deposition (ALD) technique is an efficient way to prepare SnO₂ films at low temperature, which is based on self-limiting surface reactions by exposing sequentially on the substrate with various precursors and reactants. It is enabling precise thickness control at the angstrom or monolayer level and deposition on high aspect ratio nanostructures with excellent step coverage.^[16] Since this technique is known to provide a good film and device performance compared with

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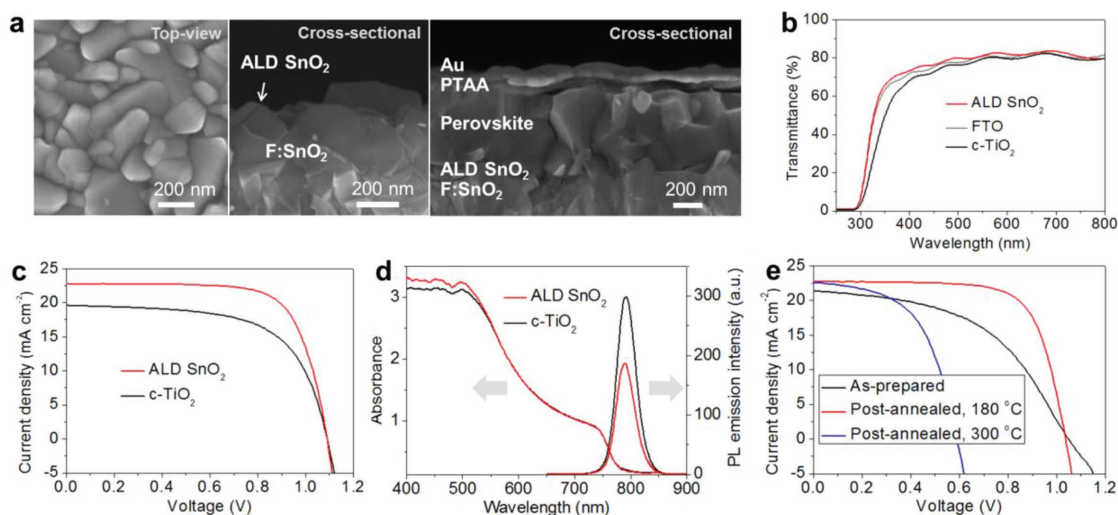


Figure 1. Planar type perovskite solar cells with ALD SnO₂ ETLs. a) SEM images of the ALD SnO₂ films and the complete perovskite solar cell. b) Transmittance of the ALD SnO₂, FTO, and c-TiO₂ films. c) *J*-*V* curves with SnO₂ and c-TiO₂ films. d) Absorbance and photoluminescence emission spectra of the perovskite films formed on the ALD SnO₂ and c-TiO₂ substrates. e) *J*-*V* curve change according to postannealing of ALD SnO₂ films.

solution-processed ones,^[17] we prepared SnO₂ layers using the ALD method by modulating deposition or postannealing temperature, and showed how temperature can influence on optical, chemical, and electrical properties of the SnO₂ film along with the device performance.

The microstructures from scanning electron microscope (SEM) of the ALD SnO₂ films deposited at 120 °C and the complete perovskite device are displayed in **Figure 1a**. A smooth and conformal SnO₂ layer without pinholes is observed over the fluorine-doped SnO₂ (FTO) top-surface. The complete cell of a planar structure is composed of FTO/ALD SnO₂/perovskite/poly triarylamine (PTAA)/gold layers. In this structure, ALD SnO₂ functions as an ETL, while perovskite, PTAA, and gold work as a light absorber, a hole transporting material (HTM), and a counter electrode, respectively. The optical property of compact TiO₂ (c-TiO₂) and ALD SnO₂ films was compared by measuring transmittance. As shown in **Figure 1b**, slightly improved transmittance than the FTO substrate from 20 nm thick ALD SnO₂-coated film is measured while decreased transmittance is observed from the 20 nm thick TiO₂-coated FTO substrate. The ALD SnO₂ ETL gave a better device performance than the c-TiO₂ ETL as shown in the *J*-*V* curves of **Figure 1c**. As the low-temperature-processed SnO₂ film is likely to have a similar conduction band position, it is reasonable to find a similar *V*_{oc} with both SnO₂ and TiO₂.^[13] The higher short-circuit current density (*J*_{sc}) and FF obtained from the cell with ALD SnO₂ ETL can be surmised by the better light harvesting and electron extraction at the interface. Despite the negligible difference of light absorption at the longer wavelength as seen in **Figure 1d**, the better absorption in the shorter wavelength region seems to be beneficial for increasing a current output. As the difference in electron extraction can be mirrored by photoluminescence (PL) emission, we measured PL of perovskite films with FTO/c-TiO₂ and FTO/ALD SnO₂ substrates, respectively. Considering both perovskite layers have the same thickness, charge collection can be differentiated by the interfacial condition. Compared with the TiO₂/perovskite film, much lower PL intensity, ≈40% reduction, is observed

from the SnO₂/perovskite film as displayed in **Figure 1d**. A reduced PL intensity with the SnO₂/perovskite film indicates that the excited electrons in perovskite can be quenched more quickly at the SnO₂/perovskite interface than that of TiO₂/perovskite. These results strongly support the reasons of the higher efficiency with the ALD SnO₂ ETL shown in **Figure 1c**. As the postannealing at a mild temperature of 180 °C is known to enhance an electrical property of the solution-processed film, it is necessary to verify if the improvement occurs similarly even with ALD SnO₂ films.^[11,13] The *J*-*V* curves of the perovskite cells with postheated films are shown in **Figure 1e**. For comparison, the SnO₂ films are deposited at 100 °C, which is slightly lower than reference temperature of 120 °C. An S-shaped curve with the as-prepared film maybe owing to incomplete conversion of the precursor which can cause a high series resistance of the device is observed. As expected, highly enhanced FF and a slightly improved *J*_{sc} are displayed after heating the film at 180 °C. However, the film heat-treated at a higher temperature of 300 °C shows a severe drop of *V*_{oc}. The observed phenomenon amazingly equals well with our previous results with SnCl₄ and water precursors.^[13] In **Figure S1** in the Supporting Information, the ALD SnO₂ films show a dense form without visible morphology change even after postannealing at 300 °C; thus, we can assume that the ALD SnO₂ film prepared at low temperature also has the passivated tin oxide (PTO) structure.^[13] We also investigated the perovskite film morphology and crystallinity on c-TiO₂ and ALD SnO₂ substrates and found no distinct change by the substrates as seen in **Figures S2** and **S3** in the Supporting Information, respectively.

To see the influence of postannealing temperature, samples deposited at 100 °C on SiO₂/Si substrate and postannealed at 180 and 300 °C were investigated by tip-enhanced Raman spectroscopy (TERS) as seen in **Figure 2a**. One major peak was identified at 469 cm⁻¹, which was assigned to the Raman active E_g mode associated with the α_{xz} polarizability tensor,^[18] which indicates the presence of primarily one crystalline orientation in reference to the instrument tip.^[19] To compare the intensities of the

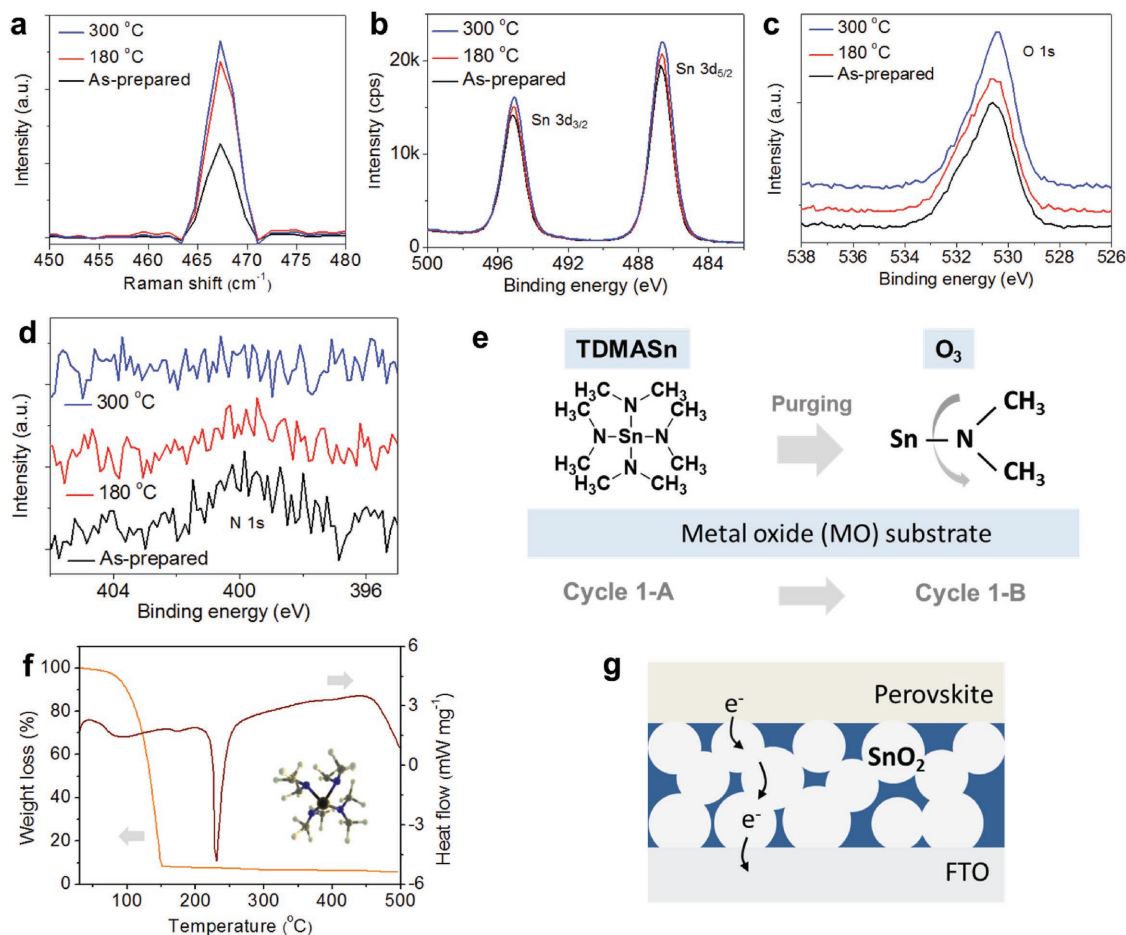


Figure 2. Characterization of the surface property of the ALD SnO₂ film as a function of postannealing temperature. a) TERS result. b–d) XPS spectra. e) Schematic of the probable reaction during ALD deposition using TDMASn and O₃ precursor. f) TG and DSC spectra of the TDMASn precursor. g) The proposed structure of the low-temperature-processed ALD SnO₂ film. The SnO₂ particles are self-passivated by the residual precursor depicted as a blue region.

SnO₂ Eg peaks, the TER spectra were normalized to the Si peak at 521 cm⁻¹ since the portion of substrate probed is constant. Raman scattering intensity was weakest in the 100 °C deposited sample and strongest in the 300 °C annealed sample, while the 180 °C annealed sample exhibited more intense Raman scattering than the 100 °C sample. This suggests that the films postannealed at higher temperature are more crystalline and of primarily one orientation than the 100 °C annealed film. As the ALD SnO₂ films prepared at low temperature are known to have an amorphous nature, the result of TERS seems to match well with that of X-ray diffraction (XRD) spectroscopy.^[20,21] X-ray photoemission spectroscopy (XPS) analysis was performed to characterize the film property. Strong peaks at 487 and 495 eV attributed to Sn⁴⁺ ions indicate the formation of SnO₂ and small shift according to annealing temperature, which implies that the chemical change of the film is seen in Figure 2b.^[22] The higher intensities in the postannealed films reveal that the crystallinity of ALD SnO₂ film has been improved, which is consistent with obtained values from TER analysis. A weak asymmetry shown in all spectra can be reasoned by Sn²⁺ ions originated from oxygen vacancy (V_o) of the SnO₂ surface, which is assumed as the origin of the high conductivity of the SnO₂ film.^[12,22] Strong

asymmetry of the spectra indicating the presence of subbands is also observed in O 1s region (Figure 2c), which can be deconvoluted into two subpeaks as shown in Figure S4 in the Supporting Information. The fitted peak with higher intensity at 530.2 eV should be assigned to the binding energy for O–Sn bond (Sn⁴⁺), while the small one at 531.5 eV can be associated with oxygen impurities such as OH ligands and water adsorption on the film.^[20–22] The impurity peak is still found even after postannealing at 300 °C with considerable intensity. In contrast, we can find a distinct change of N 1s intensity at 400 eV, which is attributed to N–Sn and N–C bonds as displayed in Figure 2d. It is seen that the highest intensity of the as-prepared film slightly decreases after 180 °C annealing, while no visible N bond appears after annealing at 300 °C. The result indicates that the unreacted precursor remains on the films prepared at the low-temperature deposition (as-prepared film) and annealed at 180 °C, as discussed in the previous reports.^[20,23] The expected reaction during the ALD-based process is illustrated in Figure 2e. For the complete conversion, the Sn–N bond should be broken and reacted by oxygen to form SnO₂, otherwise, the residual tetrakis-dimethyl-amine-tin (TDMASn) remains as an impurity on the film.^[20,23] To better understand, we analyzed the

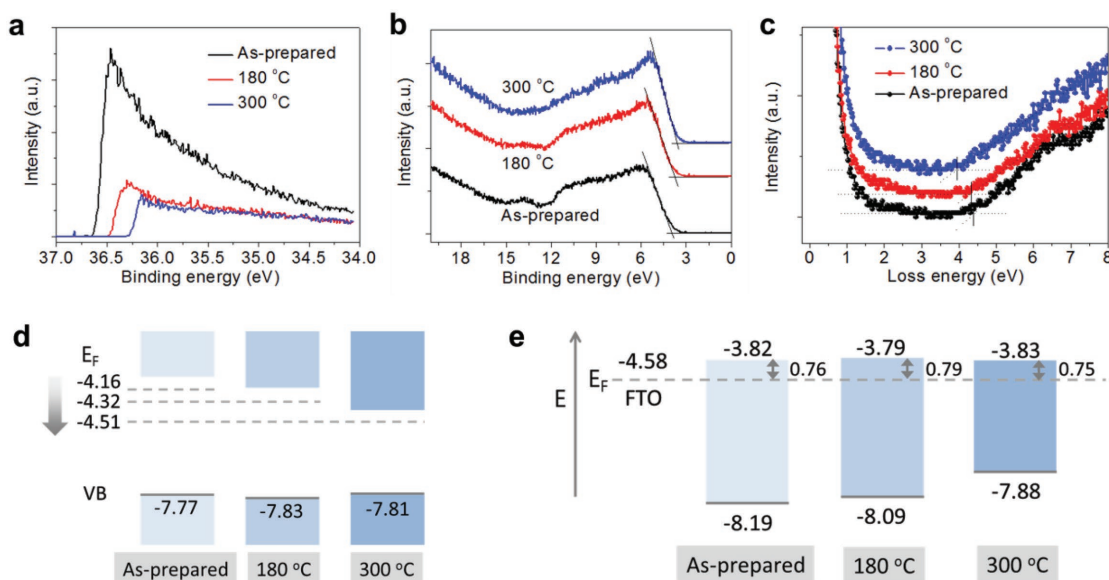


Figure 3. Energy band structure of the ALD SnO₂ films according to postannealing temperature. a) Cut-off binding energy measured by UPS. b) Valence band edge measured by UPS. c) Bandgap of the SnO₂ films measured by REELS. d) Bandgap edges and Fermi levels of the SnO₂ films as a function of annealing temperature. e) Estimated CB offsets after Fermi level alignment under heterojunction with FTO and perovskite (in the dark).

TDMASn precursor by thermogravimetry (TG) and differential scanning calorimetry (DSC) as shown in Figure 2f. It is seen that the weight loss occurs rapidly in a range between 70 and 150 °C, with a total weight loss of $\approx 92\%$. The DSC result shows one endothermic peak at 230 °C, indicating that the decomposition of the precursor and the residual precursor can coexist with SnO₂ below the temperature.^[23,24] From our observation, we can draw a probable structure of the SnO₂ ETL as depicted in Figure 2g. The structure contains highly conductive crystalline SnO₂ self-passivated by the properly controlled residual precursor, which provides good electron mobility and hole-blocking ability as well as an amorphous nature of the PTO layer. When combining with device results shown in Figure 1e, it becomes clearer that the passivation of SnO₂ is the key for the high efficiency.^[13]

The energy band structure of the SnO₂ films is displayed in Figure 3. Figure 3a,b shows the secondary electron cut-off binding energy and the valence band (VB) edges of SnO₂ films measured by ultraviolet photoelectron spectroscopy (UPS), respectively. The exact VB offset was determined by extrapolating the leading edge of the VB spectrum to the base line. From the spectra, VB offsets of as-deposited, 180, and 300 °C films are measured as 3.61, 3.51, and 3.30 eV, respectively. We measured bandgaps by reflection electron energy loss spectroscopy (REELS).^[25] The bandgaps of SnO₂ thin films are determined by the difference between elastic peak and onset of inelastic loss spectrum. Hence, we measured bandgap energies using an intercept of the line with a maximum negative slope near the edge to the background level as shown in Figure 3c. The bandgap energies of as-deposited, 180, and 300 °C films are measured as 4.38, 4.33, and 3.93 eV, respectively. This result shows that the bandgaps decreased as the annealing temperature increased. Fermi level was calculated using the equation, $E_F = E_{\text{cut-off}} - 40.8$ eV (irradiation energy of He II source). Thus, Fermi levels for the films can be calculated as -4.16, -4.32, and -4.51, respectively. And the valence band maximum (VBM) was determined by the

equation, $\text{VBM} = E_F - \text{VB offset}$. It should be noted that three different films have similar VBMs of -7.77, -7.83, and -7.81 eV, while the gradual downward shift of E_F and conduction band maximum (CBM) of annealed films are observed in Figure 3d as similarly seen in the recent report.^[26] The summary of the values from the measurement is displayed in Table S1 in the Supporting Information. In Figure 3e, we depicted aligned energy levels of the SnO₂ films under heterojunction with FTO and perovskite. In the dark condition, Fermi levels of SnO₂ films and perovskite (n-type) are pinned by FTO.^[27] It is interesting that all samples show similar values of CB offsets of 0.76, 0.79, and 0.75 after alignment, which indicates that the electron injection from perovskite is hardly influenced by the downward shift of CBM and E_F of SnO₂ films. Thus, the result is partially opposite to the general understanding that the lower position of the conduction band is beneficial for electron injection. Instead, we can conclude that the improved efficiency observed from the cells with the annealed SnO₂ films at low temperature is dominantly by the reduced series resistance of the SnO₂ layer with properly controlled surface passivation.

So far, much of research interest related to ALD SnO₂ was placed on enhancing electrical conductivity with high transparency for the conductive film applications. Accordingly, the residual precursor was regarded as rather harmful by increasing resistivity of the film. However, our findings demonstrate that such impurities can be beneficial or essential for photovoltaics by passivating surface defects of the SnO₂ layer if it is controlled properly. Passivation of SnO₂ can be easily controllable by manipulating the deposition and postannealing temperature as illustrated in Figure 4. We mainly examined the influence of postannealing temperature for ALD SnO₂ films, but the result with different deposition temperature displays a remarkably analogous trend as shown in Figure S5 in the Supporting Information. A strong recombination pathway that may occur when the SnO₂ film lacks hole-blocking ability is depicted in

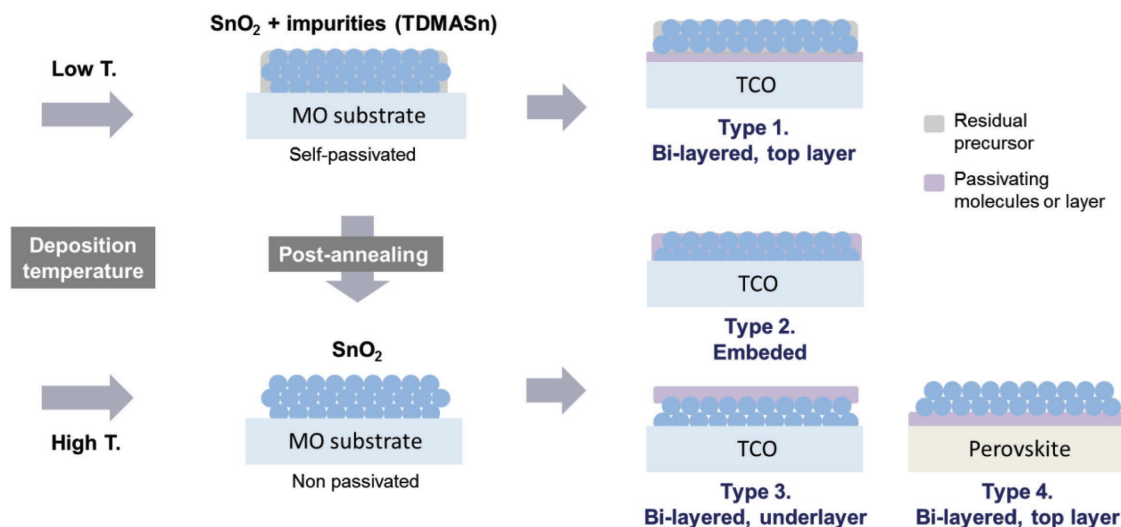


Figure 4. Self- and postpassivation of the ALD SnO₂ films. A low-temperature deposition results in incomplete conversion of the precursor, which remains on the SnO₂ film as a self-passivating layer. The schematic shows that the surface passivation of SnO₂ films can be controlled by postannealing. Four different methods of postpassivation are proposed.

Figure S6 in the Supporting Information. For comparison, we fabricated planar type cells with a thin layer of SnO₂ nanoparticles,^[28] and found a strong shunt as seen in Figure S7 in the Supporting Information. From this insight, we can draw strategies for practical passivation of the SnO₂ layer, which is classified as 4 types as sketched in Figure 4. The illustration suggests that postpassivation denoted as types 2, 3, and 4 also can be a good option to passivate the SnO₂ layer.

In this work, we introduced “Type 1” passivation, which combines a thin TiO₂ underlayer with a PTO top layer,^[13] and achieved enhanced PCEs as seen in Table S2 in the Supporting Information. A *J*-*V* curve for the champion cell is shown in Figure 5a. The best device shows excellent photovoltaic values in a planar structure with the *J*_{sc} of 22.67 mA cm⁻², the *V*_{oc} of 1.13 V, the FF of 0.78, and the PCE of 20.03% under 1 sunlight illumination condition when scanned backward. In the external quantum efficiency (EQE) measurement, we confirmed that the *J*_{sc} from the solar simulator (1 sun, Xe lamp) agrees with the integrated *J*_{sc} value of 23.03 mA cm⁻² as seen in Figure 5b. In Figure S8 in the Supporting Information, a small *J*-*V* curve hysteresis is still observed as similarly reported in our previous paper.^[13] For the long-term stability test, cells were stored in the dark condition without encapsulation (in the air, relative humidity, ≈20%) after every measurement. It is known that the

better interfacial condition between SnO₂ and perovskite compared with that of TiO₂/perovskite can also result in better stability of the perovskite layer.^[29] A promising result was observed that the PTO-based perovskite cells have an excellent stability over 90 days, while a cell with the c-TiO₂ ETL degrades quickly as shown in Figure 5c.

In summary, we investigated low-temperature-processed ALD SnO₂ films for perovskite solar cells and found that the SnO₂ ETL should be passivated due to metal-like nature of SnO₂. We unveil that the residual precursor, TDMASn, on the ALD SnO₂ film can be a good self-passivating material. It was found that chemical and electrical properties of the ALD SnO₂ film were strongly associated with deposition and postannealing temperature. By investigating optical, chemical, and electrical properties of the ALD SnO₂ films, we found that the charge collection from perovskite to SnO₂ can be less influenced by the downward shift of CBM and *E*_F of SnO₂ films, but strongly affected by crystallinity and proper surface passivation of the SnO₂ layer. Additionally, the bi-layered ETL of c-TiO₂/passivated SnO₂ was confirmed to provide better hole-blocking ability than a single-passivated SnO₂ layer, which resulted in the further enhanced PCE. Our findings highlight the importance of surface passivation for SnO₂-based ETLs, and explain why the low-temperature process is necessary to obtain high

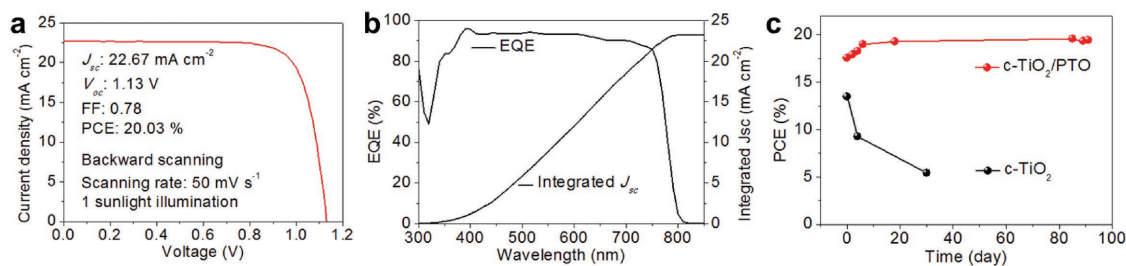


Figure 5. Performance of the best device with the bi-layered ETL. a) *J*-*V* curve of the champion cell. b) EQE and integrated *J*_{sc}. c) Long-term stability of the device without encapsulation.

PCEs. We suggest the possibility of better PCEs by efficient passivation with diverse materials for high-efficiency solar cells.

Experimental Section

Device Fabrication: FTO glass (Nippon Sheet Glass) substrates were partially etched with Zn powder and diluted HCl solution, and sequentially cleaned with detergent solution, water, and ethanol. ALD SnO₂ films were prepared with tetrakis-dimethyl-amine tin as a Sn precursor and ozone as an oxygen reactant.^[22] The deposition of ALD SnO₂ was carried out at 120 or 100 °C, and the films were used as-prepared or after postannealing. For Type 1 passivation, a compact TiO₂ layer was coated on the cleaned FTO substrate by spray pyrolysis deposition at 450 °C with a precursor solution prepared by diluting titanium diisopropoxide (Sigma-Aldrich) in ethanol. The PTO layer was formed on a c-TiO₂-coated FTO films by ALD. The deposition was carried out at 100 °C, and the as-prepared film was postannealed at 180 °C for 1 h. A thin layer of SnO₂ nanoparticles was prepared by spin coating the SnO₂ colloid precursor (Alfa Aesar, ≈2.7%). The SnO₂ layer was spin coated at 4000 rpm for 30 s, and heat-treated in the air at 150 °C for 30 min.^[28] The (FAPbI₃)_{0.85}(MAPbBr₃)_{0.15} precursor solution was prepared by mixing PbI₂ (1.10 M, TCI), FAI (1.05 M, Dyesol), PbBr₂ (0.185 M, TCI), and MABr (0.185 M, Dyesol) in a mixed solvent of DMF:DMSO = 4:1 (volume ratio). The solution was spin coated at 1000 rpm for 10 s and, continuously at 5000 rpm for 30 s. During the second step, 100 μL of chlorobenzene was poured on the film at 15 s. Films are postannealed at 100 °C for 60 min. The HTM solution was prepared by dissolving 10 mg of PTAA (Emindex) with additives in 1 mL of toluene. As additives, 7.5 μL of Li-bis(trifluoromethanesulfonyl) imide (Aldrich) from the stock solution (170 mg in 1 mL of acetonitrile), and 4 μL of 4-*tert*-butylpyridine were added. The HTM layer was formed by spin coating the solution at 3000 rpm for 30 s, and followed by the deposition of the 70 nm thick Au electrode by a thermal evaporation.

Supporting Information

Supporting Information is available from the Wiley Online Library or from the author.

Acknowledgements

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Conflict of Interest

The authors declare no conflict of interest.

Keywords

atomic layer deposition, passivation, perovskites, planar perovskite solar cells, SnO₂ electron transporting layers

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